
2SK2788

Silicon N Channel MOS FET
High Speed Power Switching

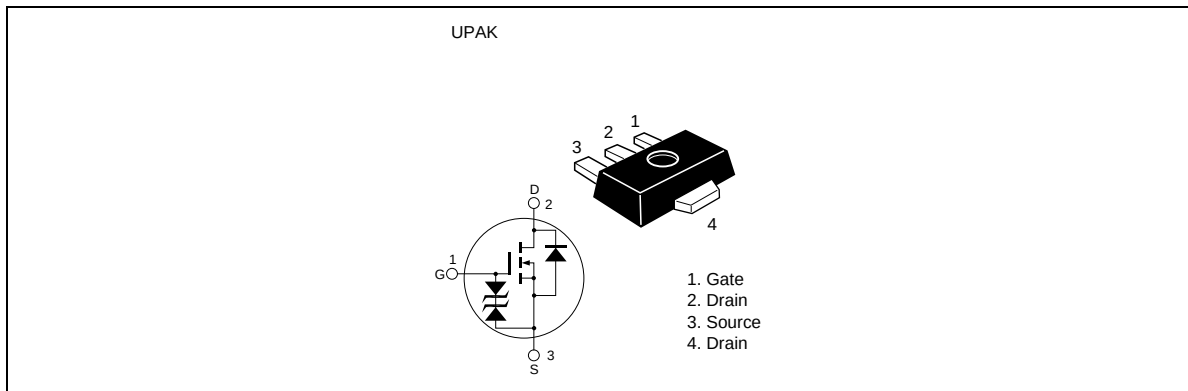
HITACHI

ADE-208-538 (Z)
1st. Edition
May 1997

Features

- Low on-resistance
 $R_{DS(on)} = 0.12\Omega$ typ ($V_{GS} = 10\text{ V}$, $I_D = 1\text{ A}$)
- Low drive current
- High speed switching
- 4V gate drive devices.

Outline



2SK2788

Absolute Maximum Ratings (Ta = 25°C)

Item	Symbol	Ratings	Unit
Drain to source voltage	V_{DSS}	60	V
Gate to source voltage	V_{GSS}	±20	V
Drain current	I_D	2	A
Drain peak current	$I_{D(pulse)}$ ^{Note1}	4	A
Body to drain diode reverse drain current	I_{DR}	2	A
Channel dissipation	P_{ch} ^{Note2}	1	W
Channel temperature	Tch	150	°C
Storage temperature	Tstg	–55 to +150	°C

Notes: 1. $PW \leq 10\mu s$, duty cycle $\leq 1\%$

2. When using the alumina ceramic board (12.5 x 20 x 0.7 mm)

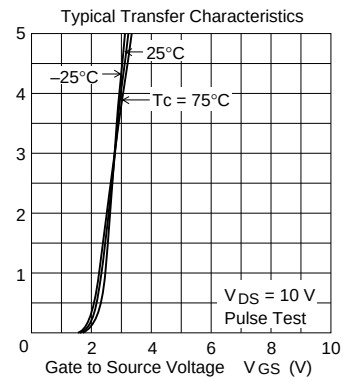
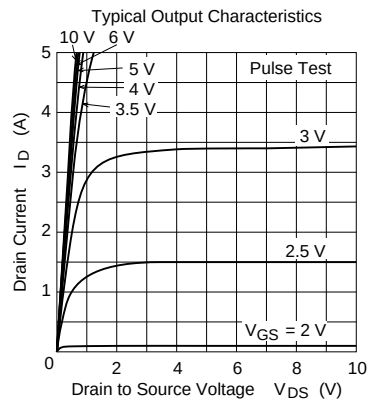
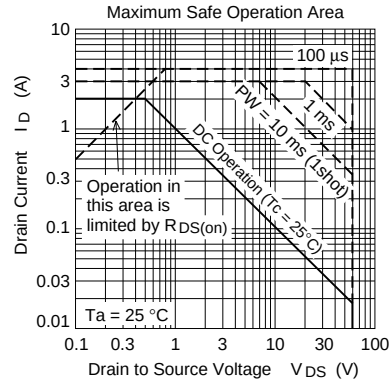
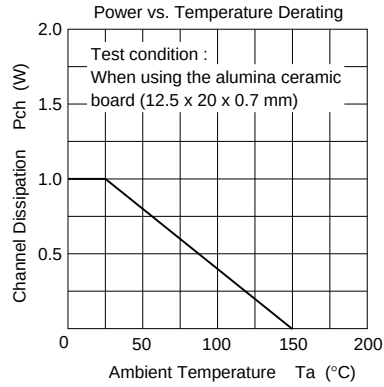
Electrical Characteristics (Ta = 25°C)

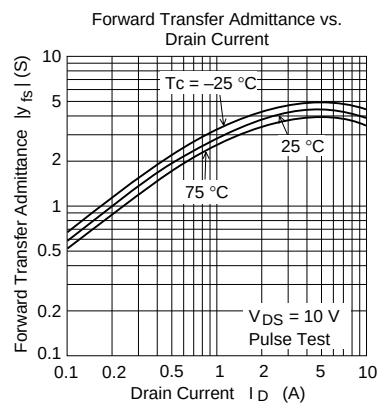
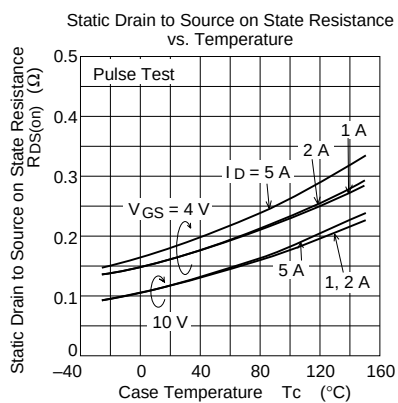
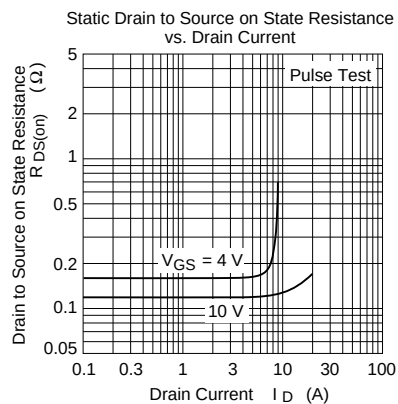
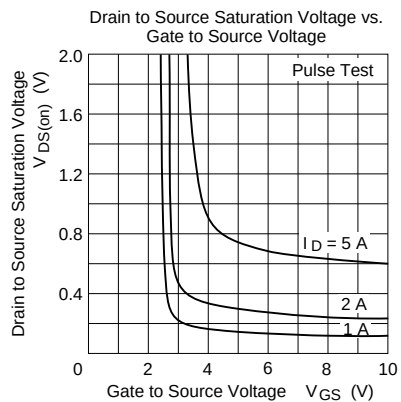
Item	Symbol	Min	Typ	Max	Unit	Test Conditions
Drain to source breakdown voltage	$V_{(BR)DSS}$	60	—	—	V	$I_D = 10\text{mA}$, $V_{GS} = 0$
Gate to source breakdown voltage	$V_{(BR)GSS}$	±20	—	—	V	$I_G = \pm 100\mu\text{A}$, $V_{DS} = 0$
Zero gate voltage drain current	I_{DSS}	—	—	10	μA	$V_{DS} = 60\text{V}$, $V_{GS} = 0$
Gate to source leak current	I_{GSS}	—	—	±10	μA	$V_{GS} = \pm 16\text{V}$, $V_{DS} = 0$
Gate to source cutoff voltage	$V_{GS(off)}$	1.0	—	2.0	V	$I_D = 1\text{mA}$, $V_{DS} = 10\text{V}$
Static drain to source on state resistance	$R_{DS(on)}$	—	0.12	0.16	Ω	$I_D = 1\text{A}$, $V_{GS} = 10\text{V}$ ^{Note3}
	$R_{DS(on)}$	—	0.16	0.25	Ω	$I_D = 1\text{A}$, $V_{GS} = 4\text{V}$ ^{Note3}
Forward transfer admittance	$ y_{fs} $	1.6	2.8	—	S	$I_D = 1\text{A}$, $V_{DS} = 10\text{V}$ ^{Note3}
Input capacitance	Ciss	—	180	—	pF	$V_{DS} = 10\text{V}$
Output capacitance	Coss	—	90	—	pF	$V_{GS} = 0$
Reverse transfer capacitance	Crss	—	30	—	pF	$f = 1\text{MHz}$
Turn-on delay time	$t_{d(on)}$	—	9	—	ns	$V_{GS} = 10\text{V}$, $I_D = 1\text{A}$
Rise time	t_r	—	15	—	ns	$R_L = 30\Omega$
Turn-off delay time	$t_{d(off)}$	—	40	—	ns	
Fall time	t_f	—	35	—	ns	
Body to drain diode forward voltage	V_{DF}	—	0.9	—	V	$I_D = 2\text{A}$, $V_{GS} = 0$
Body to drain diode reverse recovery time	t_{rr}	—	35	—	ns	$I_F = 2\text{A}$, $V_{GS} = 0$ $di_F/dt = 50\text{A}/\mu\text{s}$

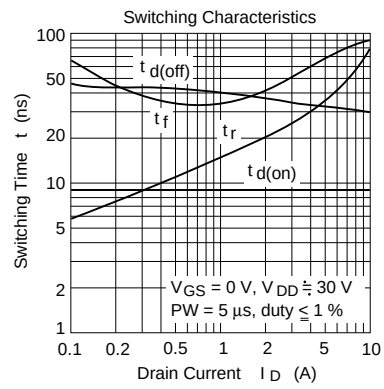
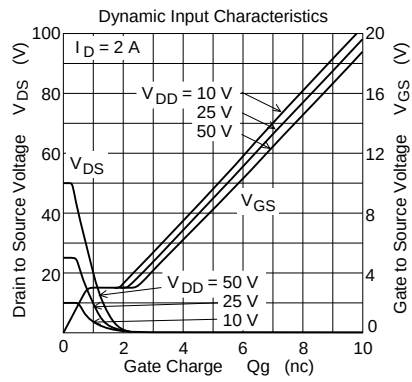
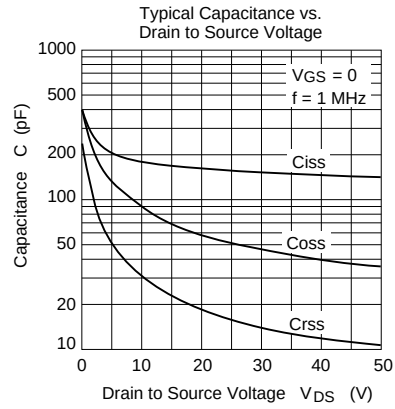
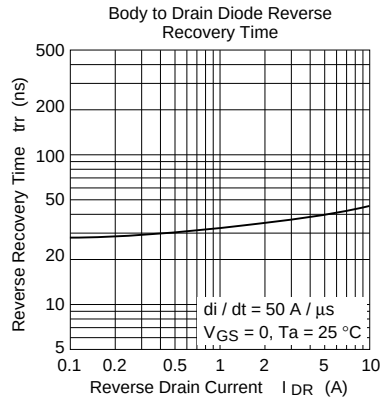
Notes: 3. Pulse test

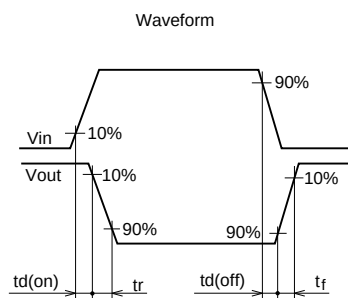
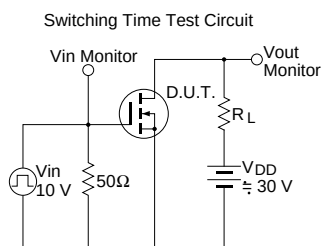
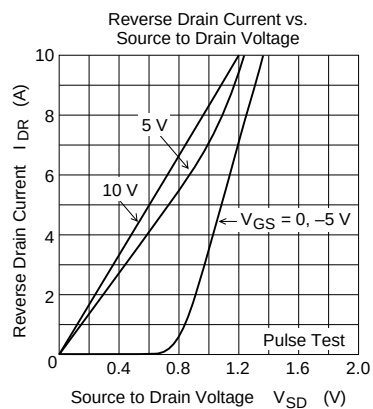
4. Marking is "VY"

Main Characteristics





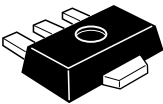
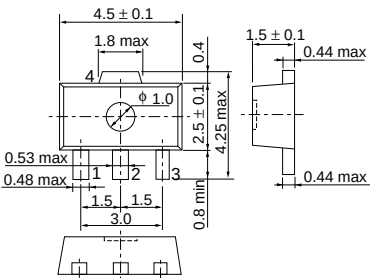




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Package Dimensions

Unit: mm



Hitachi Code	UPAK
EIAJ	SC-62
JEDEC	—

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